I hereby certify that this correspondence ling deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to "Commissioner for Patents, Washington, DC, 20231" on

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Re Application of:

Richard N. ELLSON et al.

Serial No.: 09/964,215

Group Art Unit: 1627

Filing Date: September 25, 2001

Examiner: Maurie BAKER

Title: HIGH DENSITY MOLECULAR ARRAYS ON POROUS SURFACES

## SECOND SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents Washington, DC 20231

Sir:

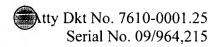
This is a Second Supplemental Information Disclosure Statement submitted for the Examiner's consideration. Applicants respectfully request that the Examiner review and make of record the references identified below.

A PTO-1449 form listing the references accompanies this paper. Applicants would appreciate the Examiner's initialing and returning the form to indicate that the references have been reviewed and made of record. The references are as follows:

U.S. PATENT DOCUMENTS		
Document No.	Issue Date or Publication Date	Name of Patentee or Applicant
2002/0037359	3/28/02	Mutz et al.
2002/0042077	4/11/02	Ellson
2002/0061598	5/23/02	Mutz et al.
Serial No. 09/669,267	Filed 9/25/00	Ellson
Serial No. 09/669,997	Filed 9/25/00	Mutz et al.

This Second Supplemental Information Disclosure Statement is not intended as a representation that a search has been made, that additional information material to the examination of this application does not exist, or that any of the above references constitutes prior art to the present application within the meaning of 35 USC § 102.

As applicants have not yet received a first Action on the merits, no fee is required for filing this Second Supplemental Information Disclosure Statement. If, however, the PTO finds



that for some reason a fee is found to be necessary, our Deposit Account No. 18-0580 may be charged therefor. A duplicate copy of this paper is enclosed.

Respectfully submitted,

By:

Dianne E. Reed

Registration No. 31,292

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